

### High-power semiconductor VECSELs

### Anne Tropper School of Physics and Astronomy University of Southampton

High Brightness Diode Laser Sources Workshop at the World of Photonics Congress Munich 18<sup>th</sup> June 2007



- → Introduction to the Vertical-External-Cavity Surface-Emitting Laser; a power-scalable diffraction-limited semiconductor laser
  - optical pumping
  - → external cavity intracavity access for SHG
- → high *peak* power in fs operation
- high cw power: thermal management by substrate removal, intracavity heatspreader, in-band pumping
- → VECSEL-YDFA

### **VECSEL** characteristics

- → gain element is an active mirror
- → power-scalable disc laser
  - Iarge emitting area
  - optical pumping: uniform carriers
- → TEM<sub>00</sub> beam
  - external cavity
  - → access to mode: RGB
- → spectral versatility
  - → quantum well laser
  - → 670 nm  $\rightarrow$  2.3 µm

A. C. Tropper & S Hoogland Progress in Quantum Electronics 2006

Sapphire Coherent Inc 200 mW at 488 nm









- → unprocessed wafer
- → 830-nm pump, 90-µm diameter spot
- → 190 mW @ 60°C
- → 400 mW @ 0°C
- → 30% optical/optical efficiency

Garnache, Tropper, J Phys D 2004

# 50 W peak power in 448-fs pulse



- → SESAM mode-locked VECSEL
- → 448-fs sech<sup>2</sup> pulse at 1038.5 nm
- → 1.01× Fourier limit
- → average power 40 mW @ 905 MHz
- → peak power ~50 W





## Substrate removal

- → Kuznetsov et al 1996 (Aram Mooradian's group)
- InGaAs/GaAs QW on GaAs/AIAs DBR
- GaAs substrate removed by jet-etch
- → thin, delicate structure, subject to degradation
- → 920 1150-nm region; 460 570 with IC-SHG
- benchmark results from Coherent and Osram







### Thermal lens characterization

- → Mach-Zehnder, 980-nm SML
- probe pump/no pump, lasing/non-lasing
- difference pump/no pump on 980 nm OPS chip
- → 70 W, 900 µm dia. spot lens undetectable
- > 9 W, 420 µm spot barely detectable (λ/40)





- multi-watt visible wavelengths:
- → blue; 460 nm
- → cyan; 488 nm
- → turquoise; 505 nm
- → green; 532 nm
- → yellow; 560 nm





### High power 532-nm source

- → pump spot diameter 900 µm
- → water temperature 5°C
- near diffraction-limited operation (M<sup>2</sup> ~ 1.3):
  - → 2-chip > 40 W
  - → 3-chip > 50 W
- → multimode operation
  → > 60 W with ~150 W pump







- → Introduced at Sandia (sapphire) by Alford et al (2002)
- ➔ Institute of Photonics, University of Strathclyde extended the technique to SiC, diamond, from 2003
- → chip is left intact
- heatspreader functions as intracavity etalon
- → monolithic microchip device, lens array...

#### Red VECSEL frequency doubled to ultraviolet





High Power Vertical External-cavity Surface Emitting Lasers - ISCS 2005 20-09-05

### In-well pumping

- pump light absorbed only in the wells, not the barriers
- small quantum defect and reduced thermal load
- Iow absorption efficiency overcome by sub-cavity design
- → 808-nm pump, 920-nm laser
- → >5 W output power at 39% optical/optical conversion efficiency





Stefan Lutgen CLEO 2005





with: Pascal Dupriez Johan Nilsson Andy Malinowski David Richardson Southampton ORC



10 15 20

5 6

-A 0

Time delay (ps)

-20 -15 -10

. . .

Time delay (ps)

- Stable 1055-nm 8-mW 4.6ps VECSEL MO for Ybdoped fibre power amplifier
- → 200-W average power output in 6.3-ps 910-MHz pulse train
- → 220 nJ, 35 kW

Dupriez et al. CLEO 2006

# 50 W, 110 fs VECSEL-YDFA

- → 500-fs 2-nm pulses into small core fibre amplifier
- -> parabolic regime: exponential growth of  $\Delta\lambda$  and  $\tau$
- Iclean linearly-chirped pulse



Dupriez et al. Optics Express 2006



- VECSELs potentially the most versatile of all solid state lasers
- unprocessed wafers generate 400 mW cw power, or 50 W peak – optical Stark mode-locking technique
- → thermal management  $\rightarrow$  100 W regime in a modular device
- diamond heatspreader accesses 'difficult' wavelengths; red, UV, mid-IR...
- → VECSEL-YDFA extends average power  $\rightarrow$  200 W, peak power  $\rightarrow$  35 kW